

7th International Workshop on DEPFET Detectors and Applications

Monday, 9 May 2011

Interconnection / Module Design - Lecture Room (16:30 - 18:00)

time	[id] title	presenter
16:30	[82] Module Mechanics: Update on Dimensions and Half-Module Assembly	RITTER, Martin
16:50	[75] Layout/Routing on the E-MCM and Solder Bumping Status in Mannheim	Mr KREIDL, Christian
17:10	[76] Flipchip at CNM: Belle and other collaborations	CABRUJA, Enric
17:30	[74] Summary - Next Steps - Discussion	ANDRICEK, Laci